

Dual P-Channel Enhancement Mode Power MOSFET

Description

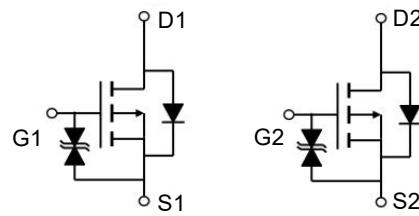
The G2K2P10S2E uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.

General Features

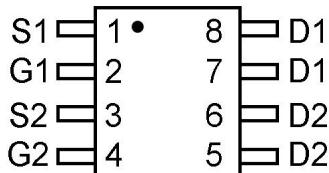
- V_{DS} -100V
- I_D (at $V_{GS} = -10V$) -3.5A
- $R_{DS(ON)}$ (at $V_{GS} = -10V$) < 200mΩ
- $R_{DS(ON)}$ (at $V_{GS} = -4.5V$) < 220mΩ
- 100% Avalanche Tested
- RoHS Compliant
- ESD (HBM) : 7KV

Application

- Power switch
- DC/DC converters



Schematic diagram



pin assignment



SOP-8

Ordering Information

Device	Package	Marking	Packaging
G2K2P10S2E	SOP-8 Dual	G2K2P10S2	4000pcs/Reel

Absolute Maximum Ratings $T_C = 25^\circ C$, unless otherwise noted

Parameter	Symbol	Value	Unit
Drain-Source Voltage	V_{DS}	-100	V
Continuous Drain Current	I_D	-3.5	A
Pulsed Drain Current (note1)	I_{DM}	-14	A
Gate-Source Voltage	V_{GS}	± 20	V
Power Dissipation	P_D	3.1	W
Single pulse avalanche energy (note2)	E_{AS}	25	mJ
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 To 150	°C

Thermal Resistance

Parameter	Symbol	Value	Unit
Thermal Resistance, Junction-to-Ambient	R_{thJA}	40	°C/W

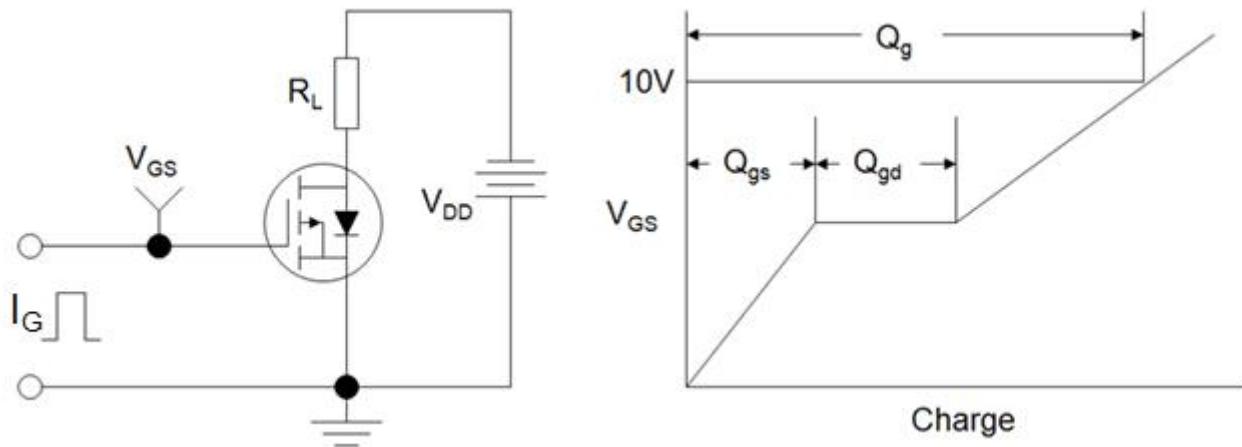
Specifications $T_J = 25^\circ\text{C}$, unless otherwise noted

Parameter	Symbol	Test Conditions	Value			Unit
			Min.	Typ.	Max.	
Static Parameters						
Drain-Source Breakdown Voltage	$V_{(\text{BR})\text{DSS}}$	$V_{GS} = 0\text{V}, I_D = -250\mu\text{A}$	-100	--	--	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = -100\text{V}, V_{GS} = 0\text{V}$	--	--	-1	μA
Gate-Source Leakage	I_{GSS}	$V_{GS} = \pm 20\text{V}$	--	--	± 10	μA
Gate-Source Threshold Voltage	$V_{GS(\text{th})}$	$V_{DS} = V_{GS}, I_D = -250\mu\text{A}$	-1.0	-1.6	-2.5	V
Drain-Source On-Resistance	$R_{DS(\text{on})}$	$V_{GS} = -10\text{V}, I_D = -3\text{A}$	--	170	200	$\text{m}\Omega$
		$V_{GS} = -4.5\text{V}, I_D = -2\text{A}$	--	180	220	
Forward Transconductance	g_{FS}	$V_{DS} = -5\text{V}, I_D = -3\text{A}$	--	10	--	S
Dynamic Parameters						
Input Capacitance	C_{iss}	$V_{GS} = 0\text{V}, V_{DS} = -50\text{V}, f = 1.0\text{MHz}$	--	1623	--	pF
Output Capacitance	C_{oss}		--	43	--	
Reverse Transfer Capacitance	C_{rss}		--	42	--	
Total Gate Charge	Q_g	$V_{DD} = -50\text{V}, I_D = -3\text{A}, V_{GS} = -10\text{V}$	--	23	--	nC
Gate-Source Charge	Q_{gs}		--	4.2	--	
Gate-Drain Charge	Q_{gd}		--	5.2	--	
Turn-on Delay Time	$t_{d(\text{on})}$	$V_{DD} = -50\text{V}, I_D = -3\text{A}, R_G = 3\Omega$	--	24	--	ns
Turn-on Rise Time	t_r		--	5	--	
Turn-off Delay Time	$t_{d(\text{off})}$		--	19	--	
Turn-off Fall Time	t_f		--	11	--	
Drain-Source Body Diode Characteristics						
Continuous Body Diode Current	I_S	$T_C = 25^\circ\text{C}$	--	--	-3.5	A
Body Diode Voltage	V_{SD}	$T_J = 25^\circ\text{C}, I_{SD} = -3\text{A}, V_{GS} = 0\text{V}$	--	--	-1.2	V
Reverse Recovery Charge	Q_{rr}	$I_F = -3\text{A}, V_{GS} = 0\text{V}$ $dI/dt = -100\text{A}/\mu\text{s}$	--	22	--	nC
Reverse Recovery Time	T_{rr}		--	29	--	ns

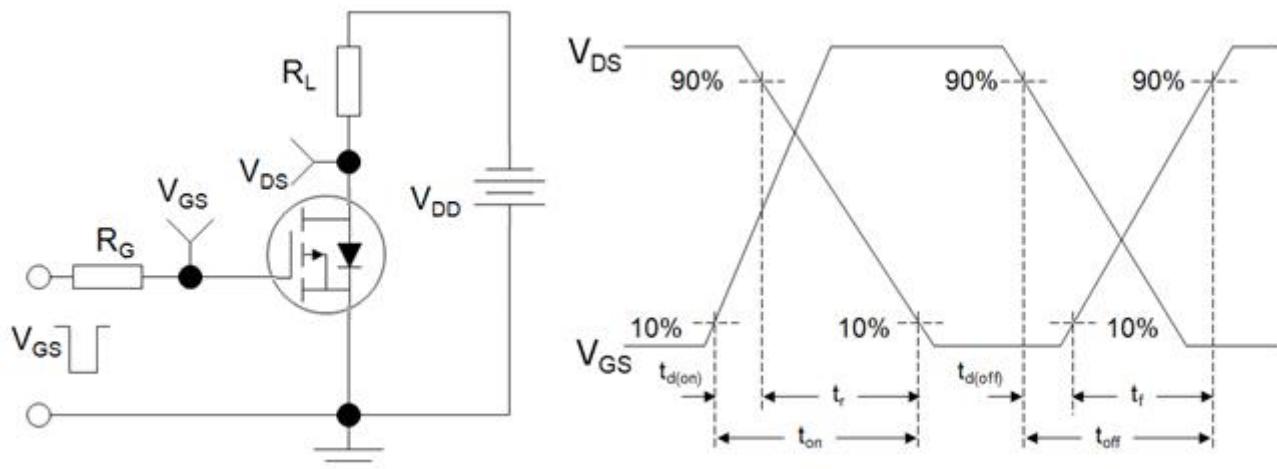
Notes

- Repetitive Rating: Pulse width limited by maximum junction temperature
- EAS condition : $T_J=25^\circ\text{C}$, $V_{DD}=-50\text{V}$, $V_{GS}=-10\text{V}$, $L=0.5\text{mH}$, $R_G=25\Omega$
- Identical low side and high side switch with identical R_G

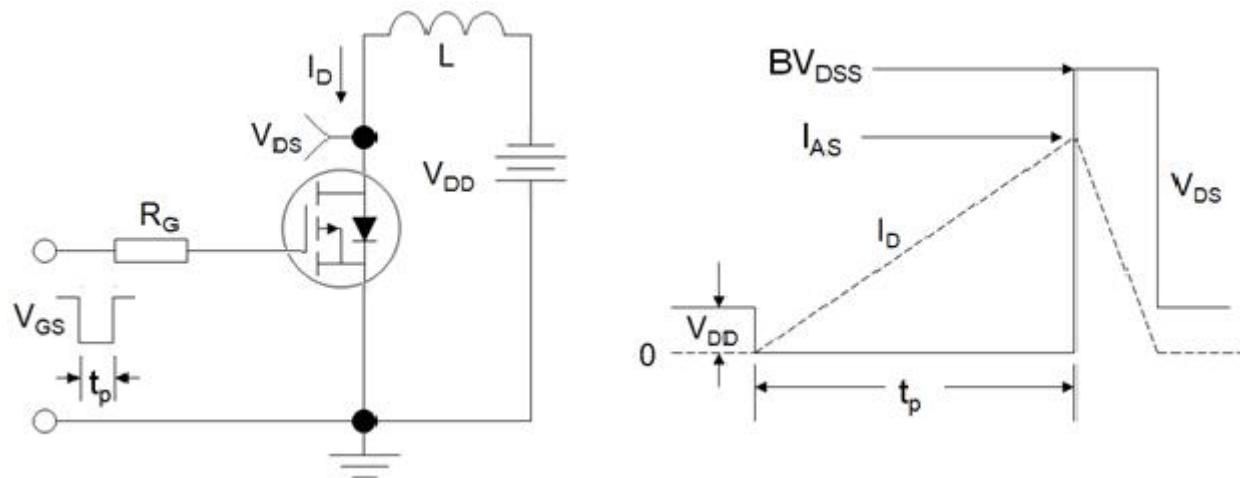
Gate Charge Test Circuit



Switch Time Test Circuit



EAS Test Circuit



Typical Characteristics $T_J = 25^\circ\text{C}$, unless otherwise noted

Figure 1. Output Characteristics

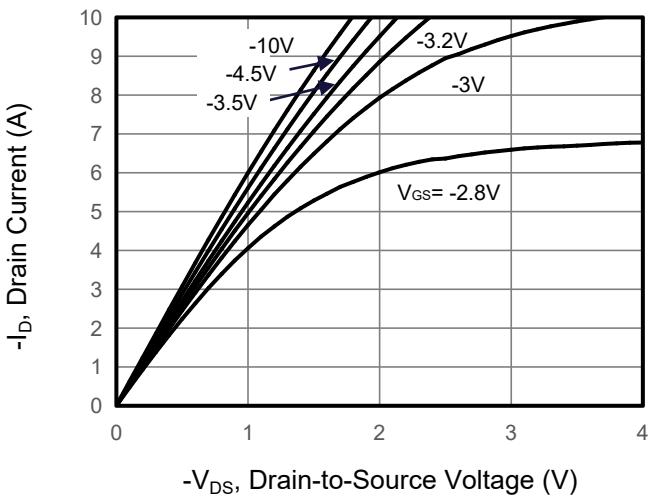


Figure 2. Transfer Characteristics

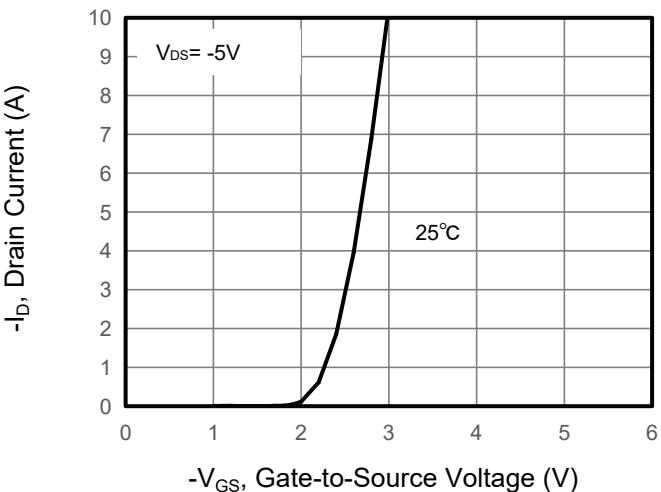


Figure 3. Drain Source On Resistance

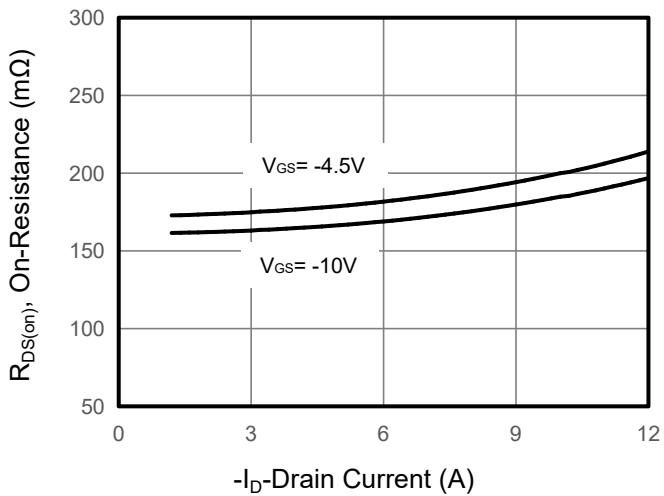


Figure 4. Gate Charge

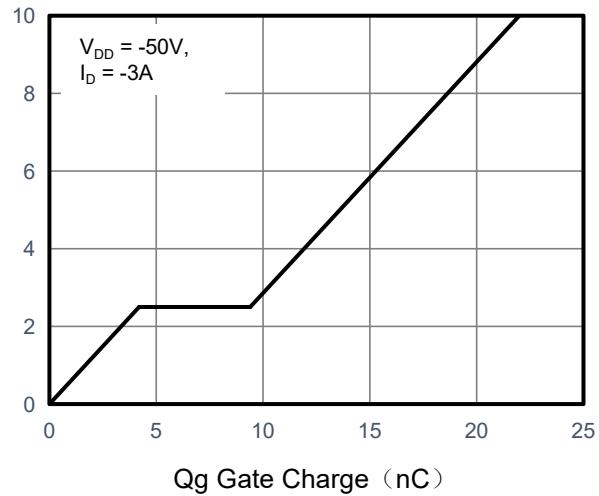


Figure 5. Capacitance

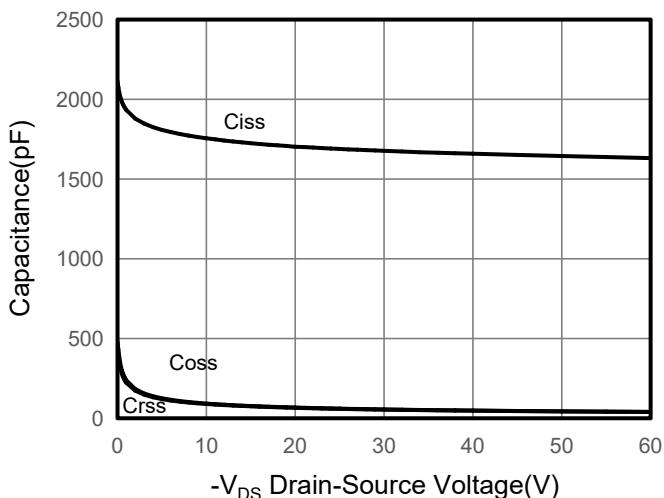
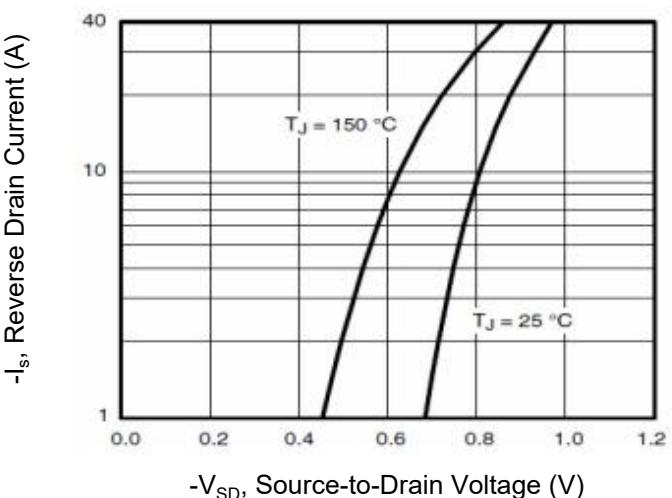


Figure 6. Source-Drain Diode Forward



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Figure 7. Drain-Source On-Resistance

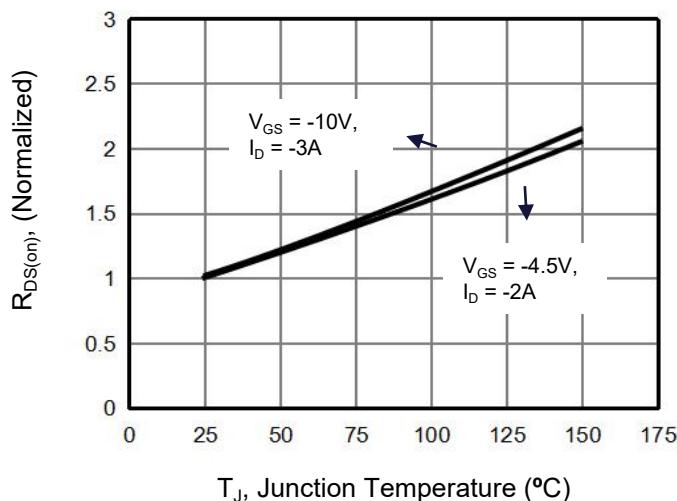


Figure 10. Safe Operation Area

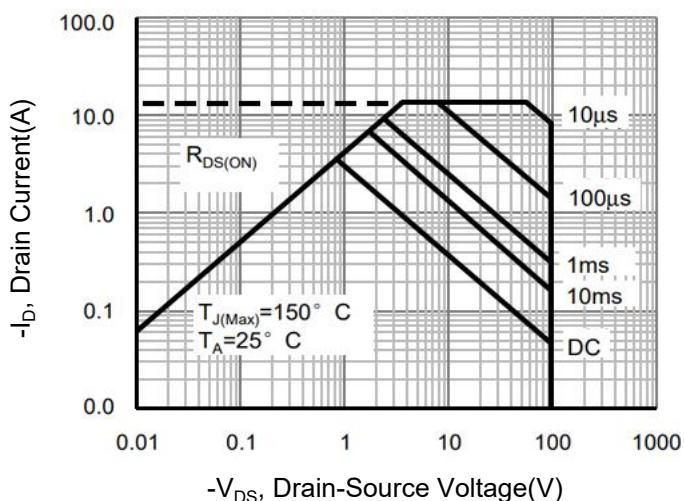
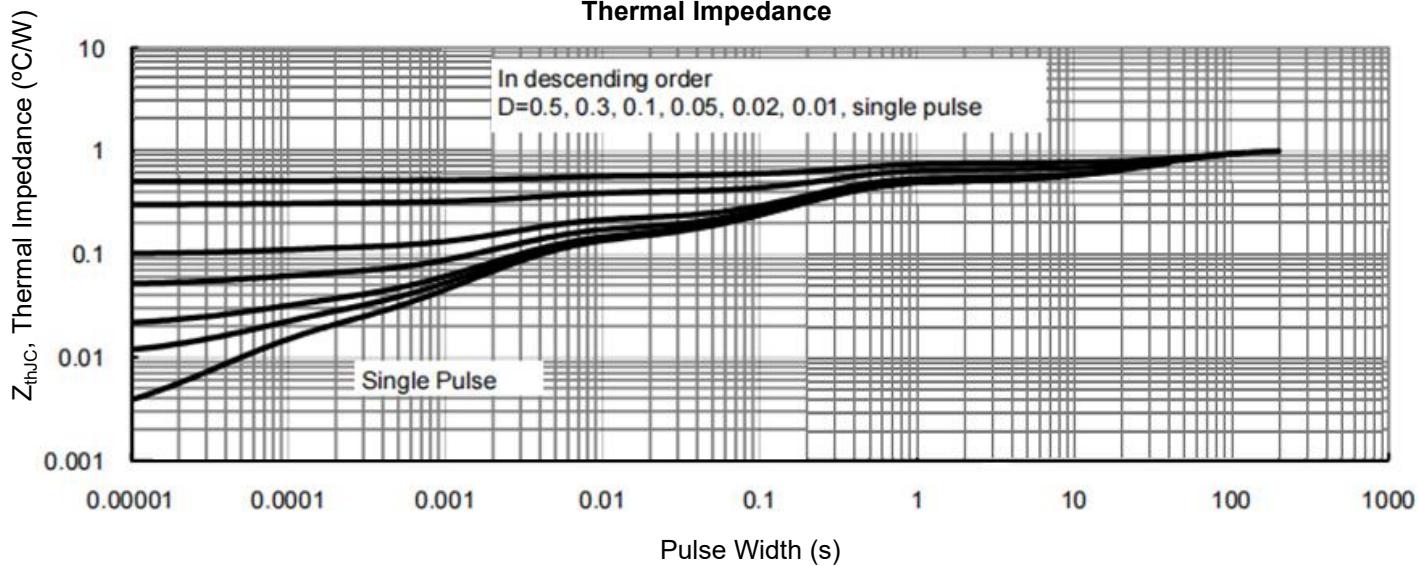
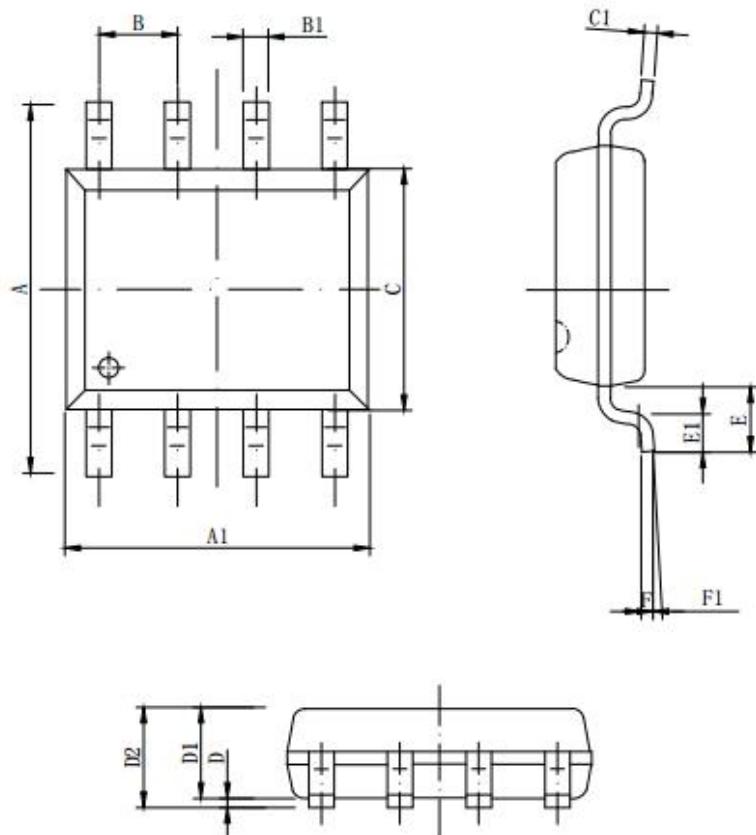


Figure 9. Normalized Maximum Transient Thermal Impedance



SOP-8 Dual Package Information

Symbol	Dimensions in Millimeters		
	MIN.	NOM.	MAX.
A	5.800	6.000	6.200
A1	4.800	4.900	5.000
B	1.270BSC		
B1	0.35^8x	0.40^8x	0.45^8x
C	3.780	3.880	3.980
C1	--	0.203	0.253
D	0.050	0.150	0.250
D1	1.350	1.450	1.550
D2	1.500	1.600	1.700
D2	1.500	1.600	1.700
E	1.060REF		
E1	0.400	0.700	0.100
F	0.250BSC		
F1	2°	4°	6°